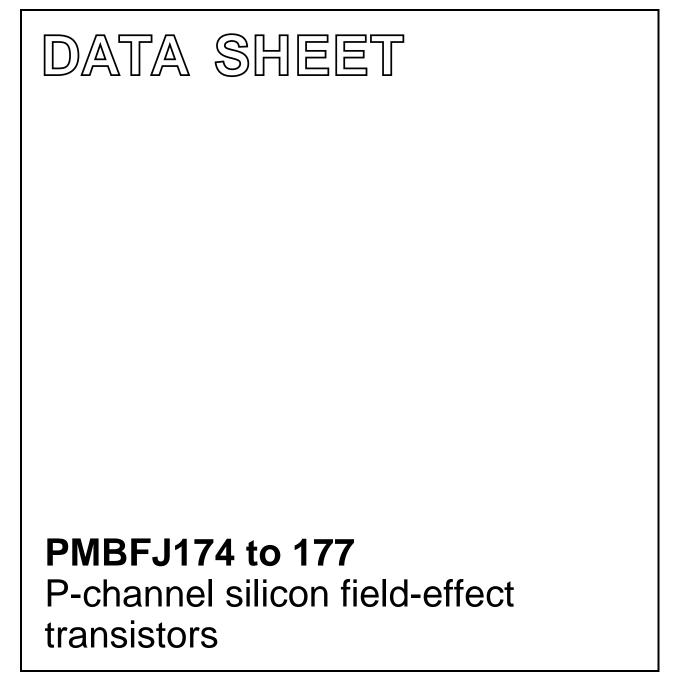
DISCRETE SEMICONDUCTORS



Product specification

April 1995



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DESCRIPTION

Silicon symmetrical p-channel junction FETs in plastic microminiature SOT23 envelopes.They are intended for application with analogue switches, choppers, commutators etc. using SMD technology. A special feature is the interchangeability of the drain and source connections.

PINNING

1 = drain

- 2 = source
- 3 = gate

Note

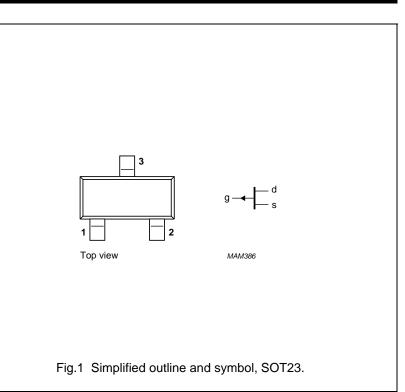
1. Drain and source are interchangeable.

Marking codes:

- 174 : p6X 175 : p6W 176 : p6S
- . 177 : p6Y

QUICK REFERENCE DATA

Drain-source voltage	$\pm V_{DS}$	max.		30		V	
Gate-source voltage	V _{GSO}	max.		30			V
Gate current	$-I_{G}$	max.		50			mΑ
Total power dissipation							
up to $T_{amb} = 25 \ ^{\circ}C$	P _{tot}	max.		300			m₩
Drain current $-V_{DS} = 15 \text{ V}; V_{GS} = 0$		PMB	FJ174	175	176	177	
		>	20	7	2	1.5	mA
	-I _{DSS}	<	135	70	35	20	mΑ
Drain-source ON-resistance							
$-V_{DS} = 0.1 \text{ V}; V_{GS} = 0$	R _{DS on}	<	85	125	250	300	Ω



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20

135

30

5

10

85

>

<

>

>

<

<

 $-I_{DSS}$

V_{(BR)GSS}

 $V_{GS off}$

 $\mathsf{R}_{\mathsf{DS}\,\mathsf{on}}$

2

35

30

1

4

250

1.5 mA

20 mA

30 V

0.8 V

2.25 V

300 Ω

7

70

30

3

6

125

RATINGS							
Limiting values in accordance with the Absolute Max	imum System (IEC 134	4)					
Drain-source voltage	$\pm V_{\text{DS}}$	max.	30		V		
Gate-source voltage	V _{GSO}	max.		30		V	
Gate-drain voltage	V _{GDO}	max.		30		V	
Gate current (d.c.)	-I _G	max.	50		50 ı		mA
Total power dissipation							
up to $T_{amb} = 25 \ ^{\circ}C^{(1)}$	P _{tot}	max.		300	C		mW
Storage temperature range	T _{stg}		-65 to + 150		°C		
Junction temperature	Τj	max.	150		C		°C
THERMAL RESISTANCE							
From junction to ambient in free air	R _{th j-a}	=		430)	I	K/W
STATIC CHARACTERISTICS							
T _j = 25 °C unless otherwise specified							
		PMBFJ	174	175	176	177	
Gate cut-off current							_
$V_{GS} = 20 V; V_{DS} = 0$	I _{GSS}	<	1	1	1	1	nA
Drain cut-off current							
$-V_{DS} = 15 \text{ V}; V_{GS} = 10 \text{ V}$	-I _{DSX}	<	1	1	1	1	nA
Drain current			20	7	0		

Note

 $-V_{DS} = 15 \text{ V}; V_{GS} = 0$

 $I_G = 1 \ \mu A; \ V_{DS} = 0$

Gate-source cut-off voltage

 $-I_D = 10 \text{ nA}; V_{DS} = -15 \text{ V}$

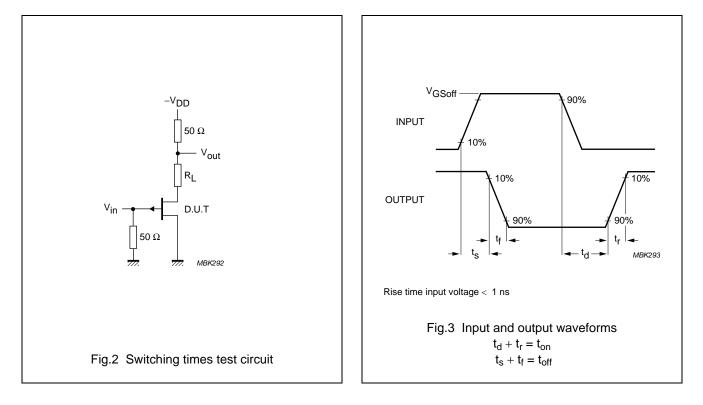
$$\label{eq:Drain-source} \begin{split} Drain-source \ ON-resistance \\ -V_{DS} = 0.1 \ V; \ V_{GS} = 0 \end{split}$$

Gate-source breakdown voltage

1. Mounted on a ceramic substrate of 8 mm \times 10 mm \times 0.7 mm.

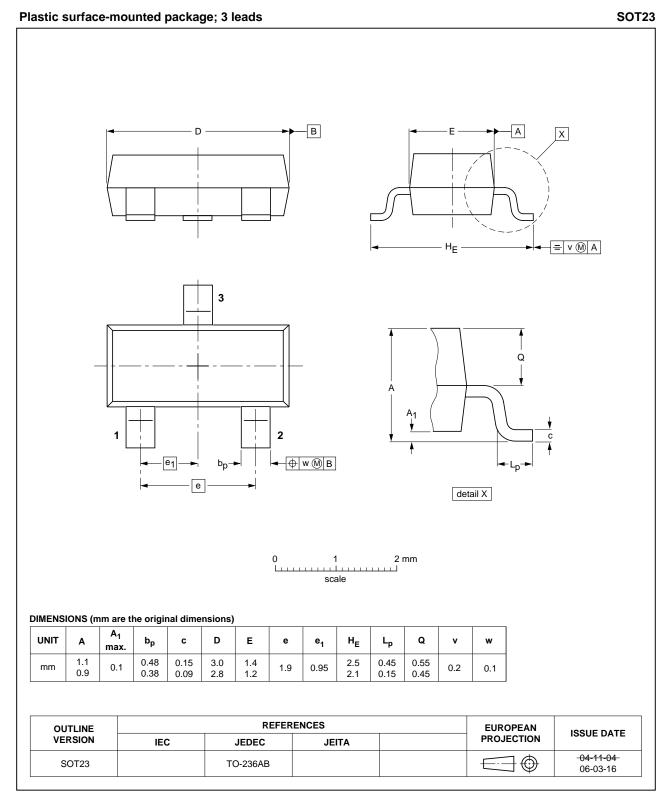
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DYNAMIC CHARACTERISTICS							
$T_j = 25 \ ^{\circ}C$ unless otherwise specified							
Input capacitance, f = 1 MHz							
$V_{GS} = 10 \text{ V}; V_{DS} = 0 \text{ V}$	Cis	typ.		8	5		pF
$V_{GS} = V_{DS} = 0$	C _{is}	typ.		30	0		pF
Feedback capacitance, f = 1 MHz							
$V_{GS} = 10 \text{ V}; V_{DS} = 0 \text{ V}$	C _{rs}	typ.		4	ļ		pF
Switching times (see Fig.2 + 3)		PMBF	J174	175	176	177	_
Delay time	t _d	typ.	2	5	15	20	ns
Rise time	t _r	typ.	5	10	20	25	ns
Turn-on time	t _{on}	typ.	7	15	35	45	ns
Storage temperature	t _s	typ.	5	10	15	20	ns
Fall time	t _f	typ.	10	20	20	25	ns
Turn-off time	t _{off}	typ.	15	30	35	45	ns
						_	
Test conditions:	$-V_{DD}$		10	6	6	6	V
	V _{GS off}		12	8	6	3	V
	R_L		560	1200	2000	2900	Ω
	$V_{GS on}$		0	0	0	0	V



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PACKAGE OUTLINE



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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Customer notification

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Contact information

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